

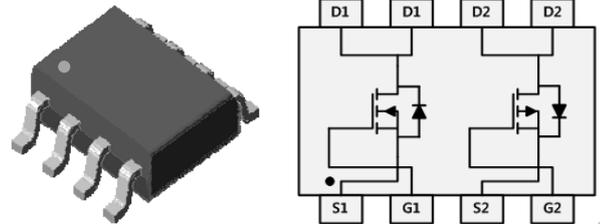
## 30V Dual N- and P-channel Trench MOSFET

### Features

- Low  $V_{GS(th)}$ :  $V_{GS(th)}=1.0\sim 3.0V$
- Small footprint due to small package
- Low  $R_{GDS(on)}$ : N-ch,  $R_{DS(on)}=24m\Omega$  (@  $V_{GS}=10V, I_D=2.9A$ )  
P-ch,  $R_{DS(on)}=66m\Omega$  (@  $V_{GS}=-10V, I_D=-2.7A$ )

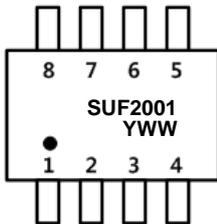
### Ordering Information

| Part Number | Marking Code | Package |
|-------------|--------------|---------|
| SUF2001     | SUF2001      | SOP-8   |



SOP-8

### Marking Information



Column 1: Device Code  
 Column 2: Production Information  
 -. Y: Year Code  
 -. WW: Week Code

### Absolute maximum ratings ( $T_A=25^\circ C$ unless otherwise noted)

| Characteristic                              | Symbol        | Rating           |                   | Unit |
|---|---------------|------------------|-------------------|------|
|   |               | N-Ch             | P-Ch              |      |
| Drain-source voltage                        | $V_{DSS}$     | 30               | -30               | V    |
| Gate-source voltage                         | $V_{GSS}$     | $\pm 20$         |                   | V    |
| Drain current (DC)                          | $I_D$         | 5.8              | -5.3              | A    |
| Drain current (Pulsed) *                    | $I_{DP}$      | 23.2             | -21.2             | A    |
| Total power dissipation **                  | $P_D$         | 2                |                   | W    |
| Avalanche current (Single)                  | $I_{AS}$      | 5.8 <sup>②</sup> | -5.3 <sup>⑥</sup> | A    |
| Single pulsed avalanche energy              | $E_{AS}$      | 72 <sup>②</sup>  | 33 <sup>⑥</sup>   | mJ   |
| Avalanche current (Repetitive) <sup>①</sup> | $I_{AR}$      | 5.8              | -5.3              | A    |
| Repetitive avalanche energy <sup>①</sup>    | $E_{AR}$      | 3.4              | 1.6               | mJ   |
| Junction temperature                        | $T_J$         | 150              |                   | °C   |
| Storage temperature range                   | $T_{stg}$     | -55~150          |                   |      |
| Thermal resistance junction to ambient      | $R_{th(J-A)}$ | 62.5             |                   | °C/W |

\* Limited by maximum junction temperature

\*\* Device mounted on a glass-epoxy board

**N-channel MOSFET Electrical Characteristics**

| Characteristic                            | Symbol       | Test Condition                       | Min. | Typ. | Max.      | Unit      |
|---|--------------|--------------------------------------|------|------|-----------|-----------|
| Drain-source breakdown voltage            | $BV_{DSS}$   | $I_D=250\mu A, V_{GS}=0$             | 30   | -    | -         | V         |
| Gate threshold voltage                    | $V_{GS(th)}$ | $I_D=250\mu A, V_{DS}=V_{GS}$        | 1.0  | -    | 3.0       | V         |
| Drain-source cut-off current              | $I_{DSS}$    | $V_{DS}=30V, V_{GS}=0V$              | -    | -    | 1         | $\mu A$   |
| Gate leakage current                      | $I_{GSS}$    | $V_{DS}=0V, V_{GS}=\pm 20V$          | -    | -    | $\pm 100$ | nA        |
| Drain-source on-resistance                | $R_{DS(on)}$ | $V_{GS}=10V, I_D=2.9A$               | -    | 24   | 30        | $m\Omega$ |
|   |              | $V_{GS}=5.0V, I_D=2.9A$              | -    | 28   | 34        | $m\Omega$ |
| Forward transfer conductance <sup>④</sup> | $g_{fs}$     | $V_{DS}=5V, I_D=5.8A$                | -    | 12   | -         | S         |
| Input capacitance                         | $C_{iss}$    | $V_{GS}=0V, V_{DS}=10V, f=1MHz$      | -    | 370  | 560       | pF        |
| Output capacitance                        | $C_{oss}$    |                                      | -    | 60   | 90        |           |
| Reverse transfer capacitance              | $C_{rss}$    |                                      | -    | 36   | 54        |           |
| Turn-on delay time <sup>③④</sup>          | $t_{d(on)}$  | $V_{DS}=15V, I_D=5.8A, R_G=10\Omega$ | -    | 1.2  | -         | ns        |
| Rise time <sup>③④</sup>                   | $t_r$        |                                      | -    | 1.1  | -         |           |
| Turn-off delay time <sup>③④</sup>         | $t_{d(off)}$ |                                      | -    | 2.5  | -         |           |
| Fall time <sup>③④</sup>                   | $t_f$        |                                      | -    | 1.1  | -         |           |
| Total gate charge <sup>③④</sup>           | $Q_g$        | $V_{DS}=15V, V_{GS}=5V, I_D=5.8A$    | -    | 4.2  | 6.3       | nC        |
| Gate-source charge <sup>③④</sup>          | $Q_{gs}$     |                                      | -    | 0.9  | 1.4       |           |
| Gate-drain charge <sup>③④</sup>           | $Q_{gd}$     |                                      | -    | 1.4  | 2.1       |           |

**Source-Drain Diode Ratings and Characteristics**

| Characteristic                      | Symbol   | Test Condition                       | Min | Typ | Max | Unit    |
|-------------------------------------|----------|--------------------------------------|-----|-----|-----|---------|
| Source current                      | $I_S$    | Integral reverse diode in the MOSFET | -   | -   | 1.5 | A       |
| Source current(Pulsed) <sup>①</sup> | $I_{SM}$ |                                      | -   | -   | 6.0 |         |
| Forward voltage <sup>④</sup>        | $V_{SD}$ | $V_{GS}=0V, I_S=1.5A$                | -   | -   | 1.2 | V       |
| Reverse recovery time               | $t_{rr}$ | $I_S=1.5A, di_S/dt=100A/us$          | -   | 90  | -   | ns      |
| Reverse recovery charge             | $Q_{rr}$ |                                      | -   | 0.5 | -   | $\mu C$ |

Note ;

- ① Repetitive Rating : Pulse width limited by maximum junction temperature
- ②  $L=3.4mH, I_{AS}=5.8A, V_{DD}=15V, R_G=25\Omega$
- ③ Pulse Test : Pulse Width < 300us, Duty cycle $\leq$ 2%
- ④ Essentially independent of operating temperature

**P-channel MOSFET Electrical Characteristics**

| Characteristic                            | Symbol       | Test Condition                         | Min. | Typ. | Max.      | Unit       |
|---|--------------|--|------|------|-----------|------------|
| Drain-source breakdown voltage            | $BV_{DSS}$   | $I_D=250\mu A, V_{GS}=0$               | -30  | -    | -         | V          |
| Gate threshold voltage                    | $V_{GS(th)}$ | $I_D=250\mu A, V_{DS}=V_{GS}$          | -1.0 | -    | -3.0      | V          |
| Drain-source cut-off current              | $I_{DSS}$    | $V_{DS}=-30V, V_{GS}=0V$               | -    | -    | 1         | $\mu A$    |
| Gate leakage current                      | $I_{GSS}$    | $V_{DS}=0V, V_{GS}=\pm 20V$            | -    | -    | $\pm 100$ | nA         |
| Drain-source on-resistance                | $R_{DS(on)}$ | $V_{GS}=-10V, I_D=-2.7A$               | -    | 66   | 72        | m $\Omega$ |
|   |              | $V_{GS}=-5.0V, I_D=-2.7A$              | -    | 77   | 83        | m $\Omega$ |
| Forward transfer conductance <sup>⑧</sup> | $g_{fs}$     | $V_{DS}=-5V, I_D=-5.3A$                | -    | 11   | -         | S          |
| Input capacitance                         | $C_{iss}$    | $V_{GS}=0V, V_{DD}=-10V, f=1MHz$       | -    | 390  | 590       | pF         |
| Output capacitance                        | $C_{oss}$    |  | -    | 97   | 150       |            |
| Reverse transfer capacitance              | $C_{rss}$    |  | -    | 37   | 60        |            |
| Turn-on delay time <sup>⑦⑧</sup>          | $t_{d(on)}$  | $V_{DS}=-15V, I_D=-5.3A, R_G=10\Omega$ | -    | 1.2  | -         | ns         |
| Rise time <sup>⑦⑧</sup>                   | $t_r$        |  | -    | 1.1  | -         |            |
| Turn-off delay time <sup>⑦⑧</sup>         | $t_{d(off)}$ |  | -    | 2.5  | -         |            |
| Fall time <sup>⑦⑧</sup>                   | $t_f$        |  | -    | 1.1  | -         |            |
| Total gate charge <sup>⑦⑧</sup>           | $Q_g$        | $V_{DS}=-15V, V_{GS}=-5V, I_D=-5.3A$   | -    | 4.7  | 7.0       | nC         |
| Gate-source charge <sup>⑦⑧</sup>          | $Q_{gs}$     |  | -    | 1.4  | 2.1       |            |
| Gate-drain charge <sup>⑦⑧</sup>           | $Q_{gd}$     |  | -    | 1.7  | 2.5       |            |

**Source-Drain Diode Ratings and Characteristics**

| Characteristic                       | Symbol   | Test Condition                       | Min | Typ | Max  | Unit    |
|--------------------------------------|----------|--------------------------------------|-----|-----|------|---------|
| Source current                       | $I_S$    | Integral reverse diode in the MOSFET | -   | -   | -1.5 | A       |
| Source current (Pulsed) <sup>⑤</sup> | $I_{SM}$ |                                      | -   | -   | -6.0 |         |
| Forward voltage <sup>⑥</sup>         | $V_{SD}$ | $V_{GS}=0V, I_S=-1.5A$               | -   | -   | -1.2 | V       |
| Reverse recovery time                | $t_{rr}$ | $I_S=-1.5A, di_s/dt=100A/us$         | -   | 90  | -    | ns      |
| Reverse recovery charge              | $Q_{rr}$ |                                      | -   | 0.5 | -    | $\mu C$ |

Note ;

- ⑤ Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
- ⑥  $L=2.0mH, I_{AS}=-5.0A, V_{DD}=-15V, R_G=25\Omega$
- ⑦ Pulse Test : Pulse Width < 300us, Duty cycle $\leq$ 2%
- ⑧ Essentially independent of operating temperature

N-CH Electrical Characteristic Curves

Fig. 1  $I_D - V_{DS}$

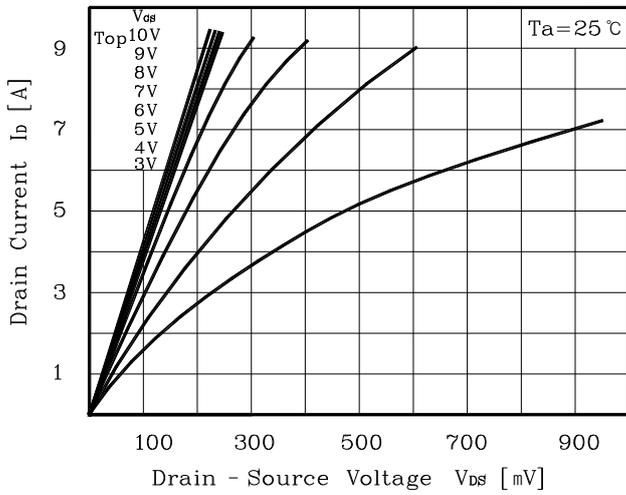


Fig. 2  $I_D - V_{GS}$

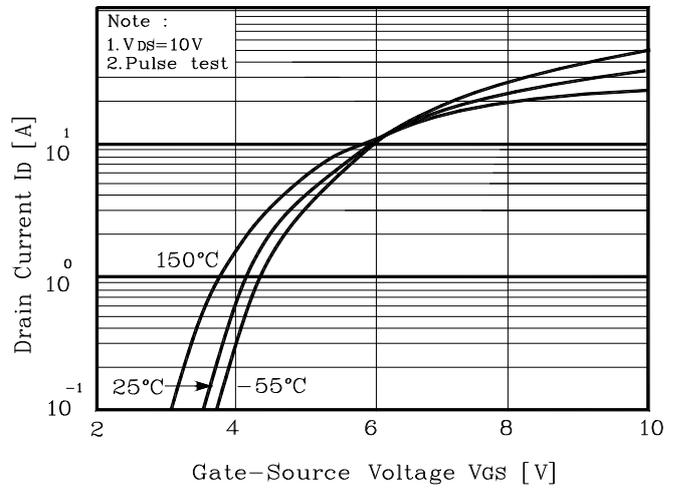


Fig. 3  $R_{DS(on)} - I_D$

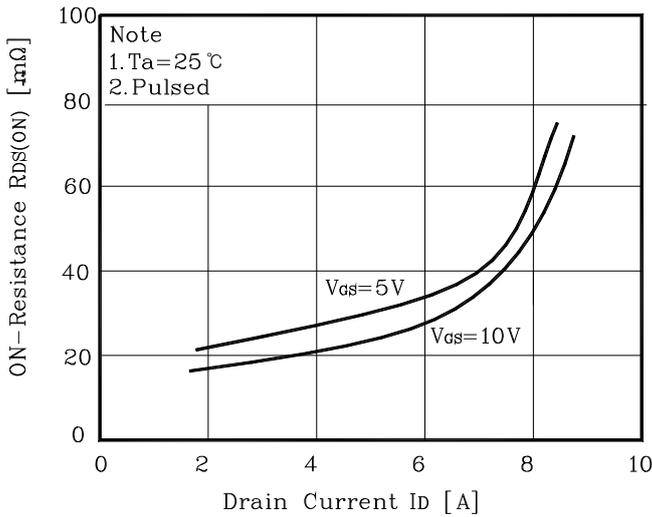


Fig. 4  $I_S - V_{SD}$

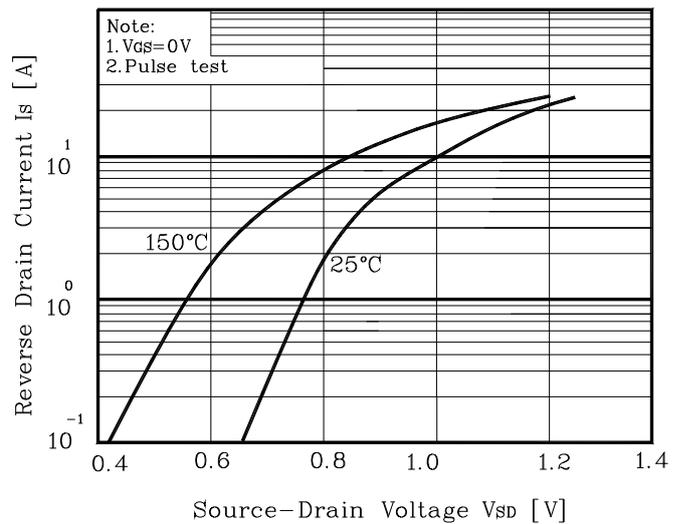


Fig. 5 Capacitance -  $V_{DS}$

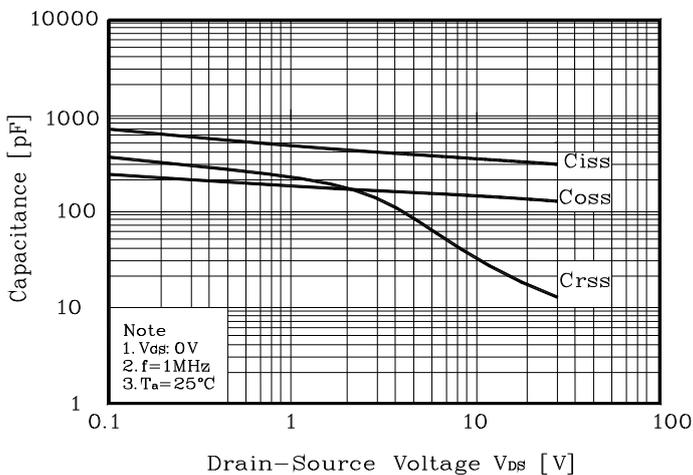
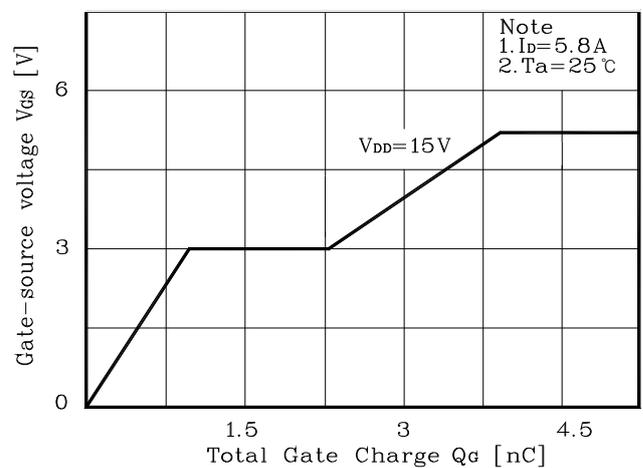
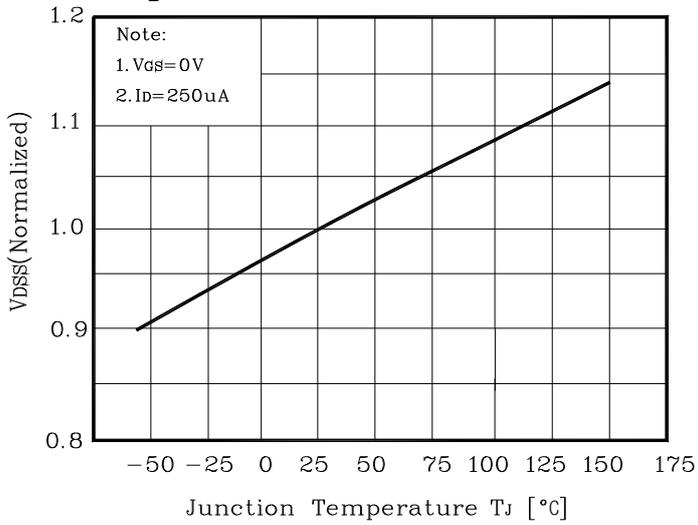


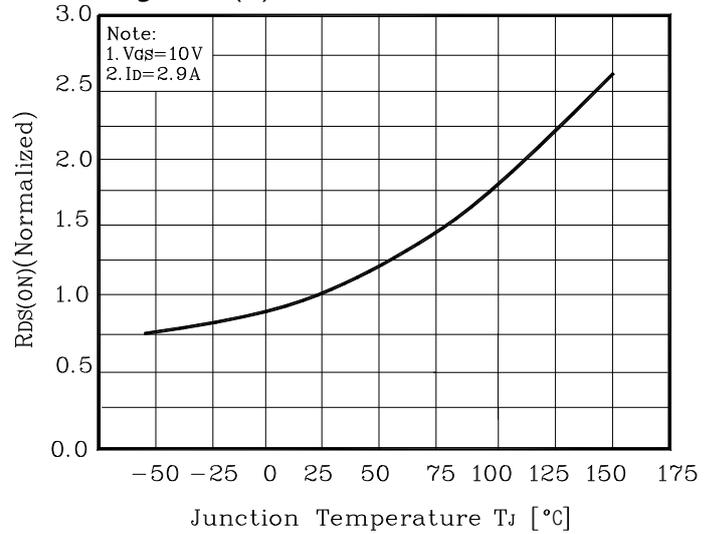
Fig. 6  $V_{GS} - Q_G$



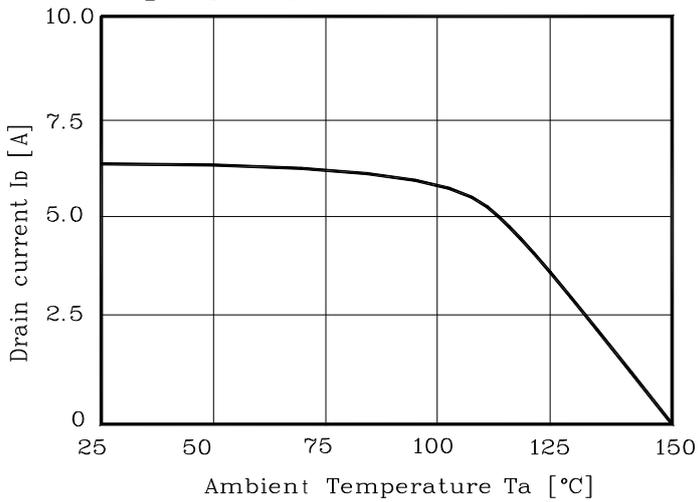
**Fig. 7  $V_{DSS} - T_J$**



**Fig. 8  $R_{DS(on)} - T_J$**



**Fig. 9  $I_D - T_a$**



**Fig. 10 Safe Operating Area**

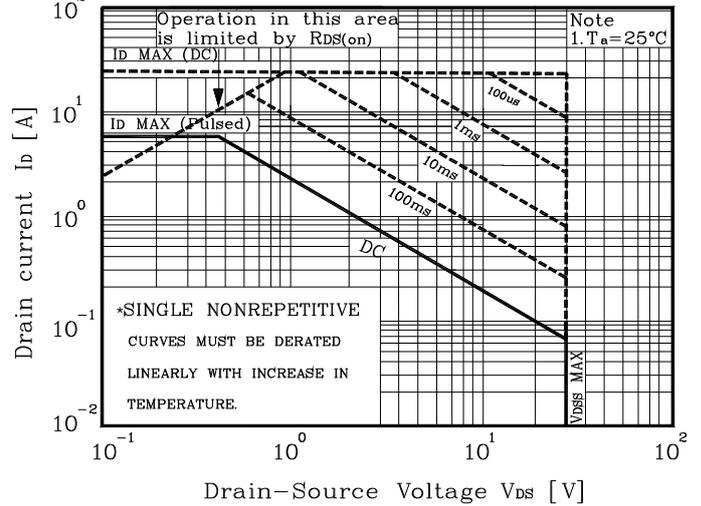


Fig. 11 Gate Charge Test Circuit & Waveform

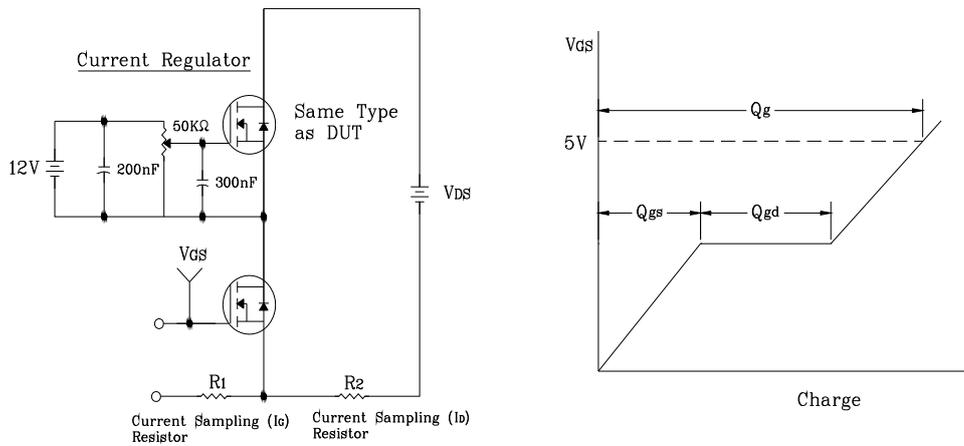


Fig. 12 Resistive Switching Test Circuit & Waveform

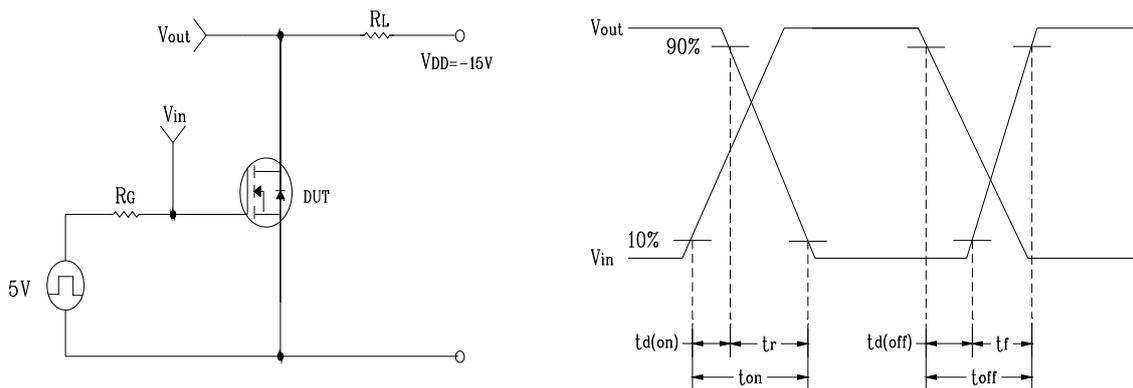


Fig. 13 E<sub>AS</sub> Test Circuit & Waveform

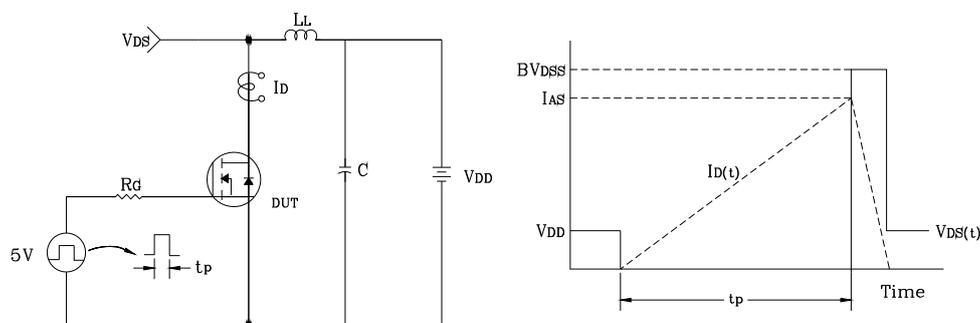
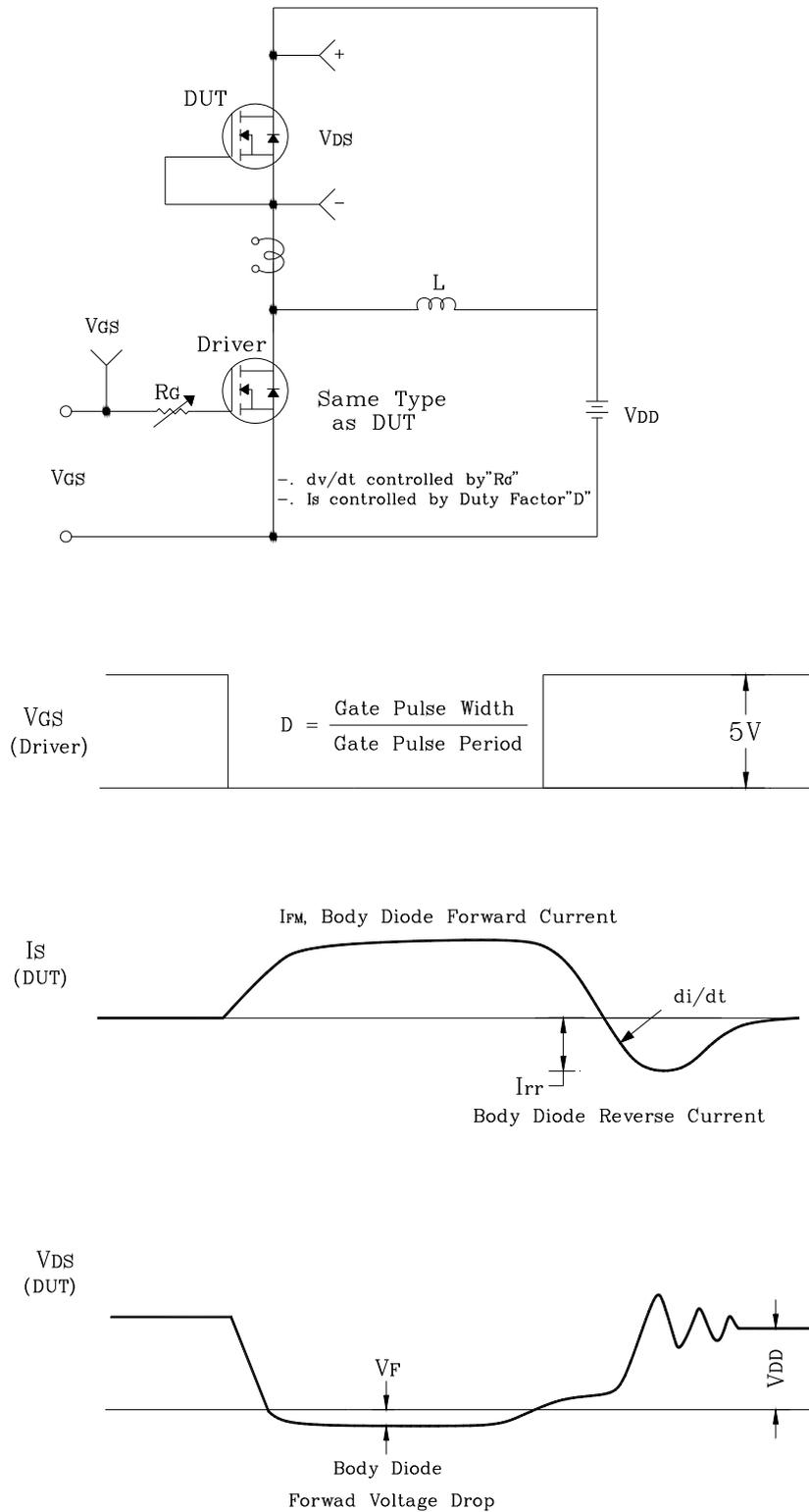


Fig. 14 Diode Reverse Recovery Time Test Circuit & Waveform



P-CH Electrical Characteristic Curves

Fig. 1  $I_D - V_{DS}$

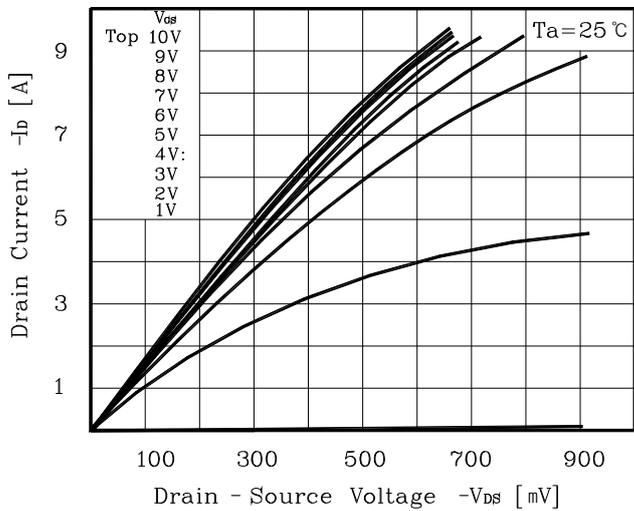


Fig. 2  $I_D - V_{GS}$

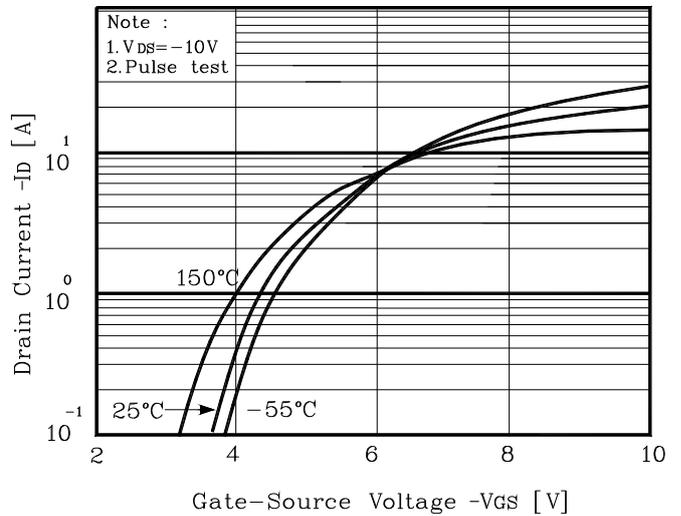


Fig. 3  $R_{DS(on)} - I_D$

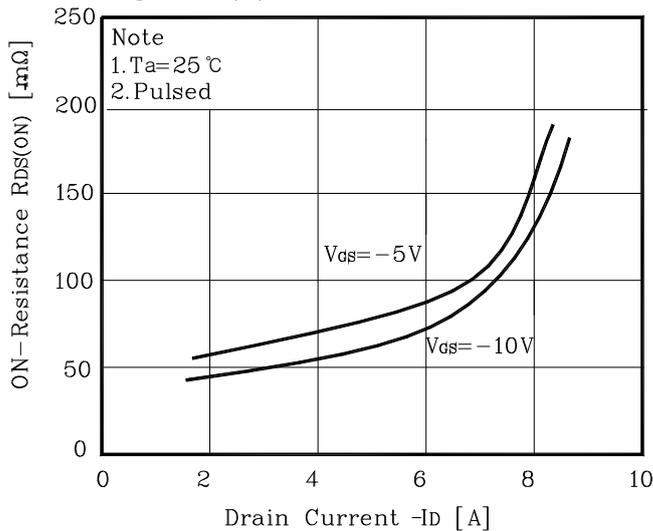


Fig. 4  $I_S - V_{SD}$

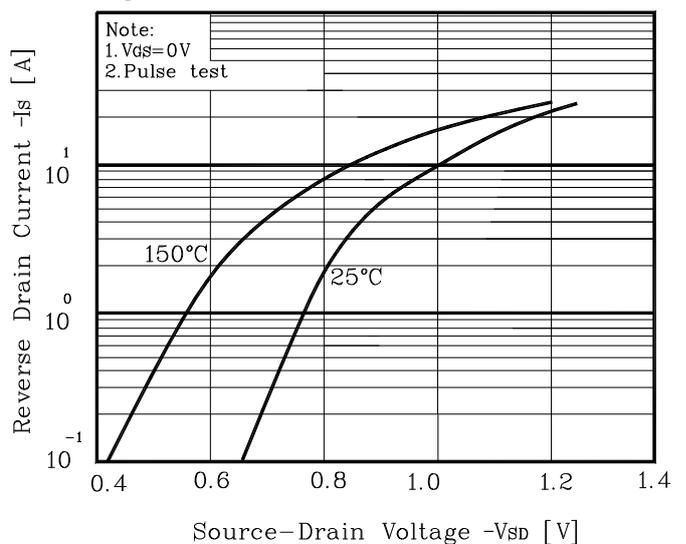


Fig. 5 Capacitance -  $V_{DS}$

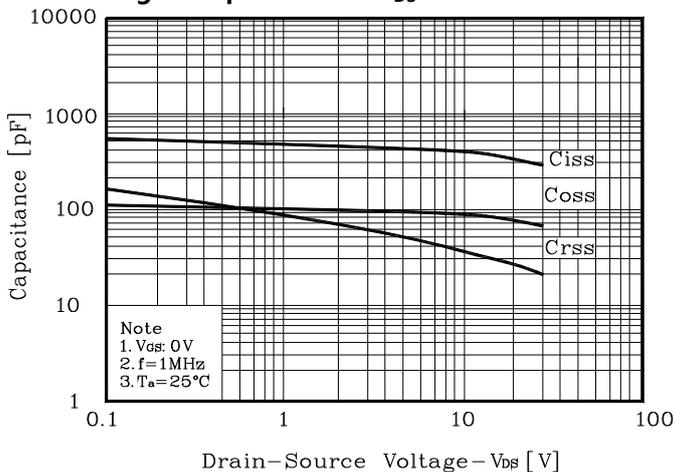


Fig. 6  $V_{GS} - Q_G$

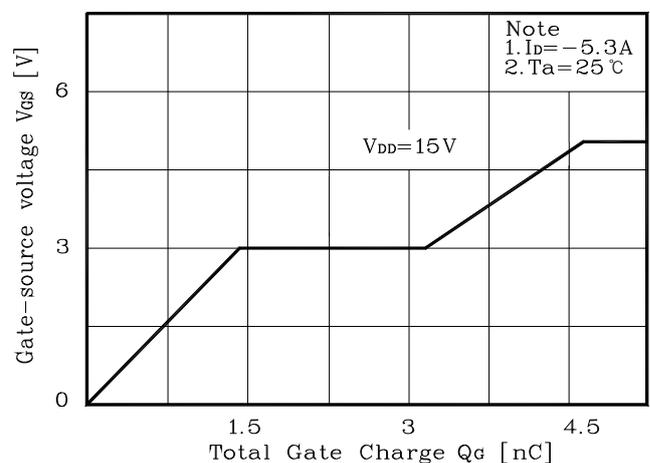


Fig. 7  $V_{DSS} - T_J$

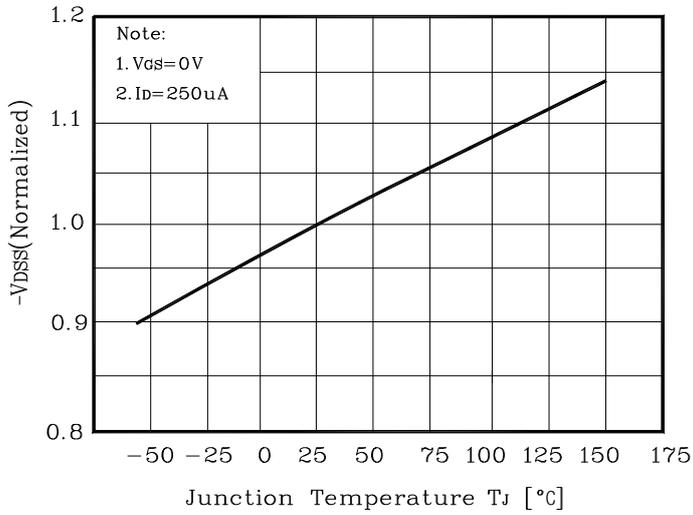


Fig. 8  $R_{DS(on)} - T_J$

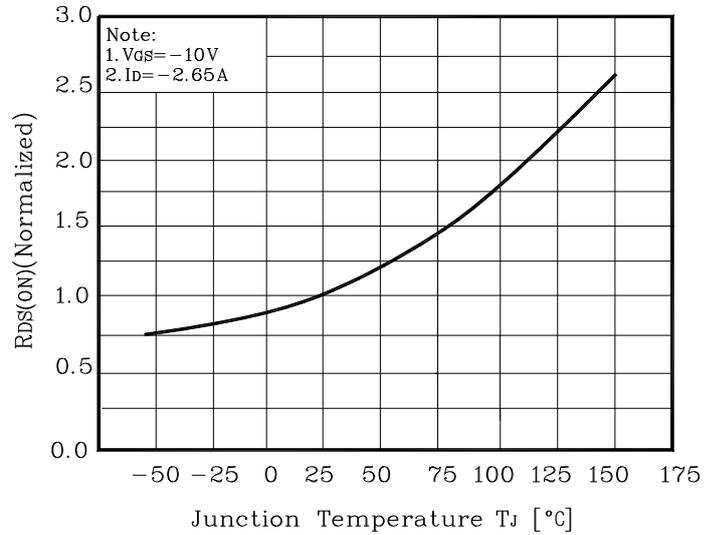


Fig. 9  $I_D - T_a$

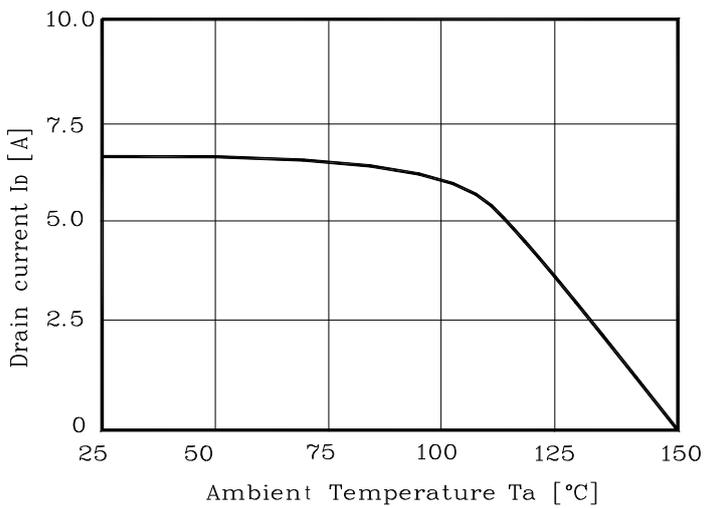


Fig. 10 Safe Operating Area

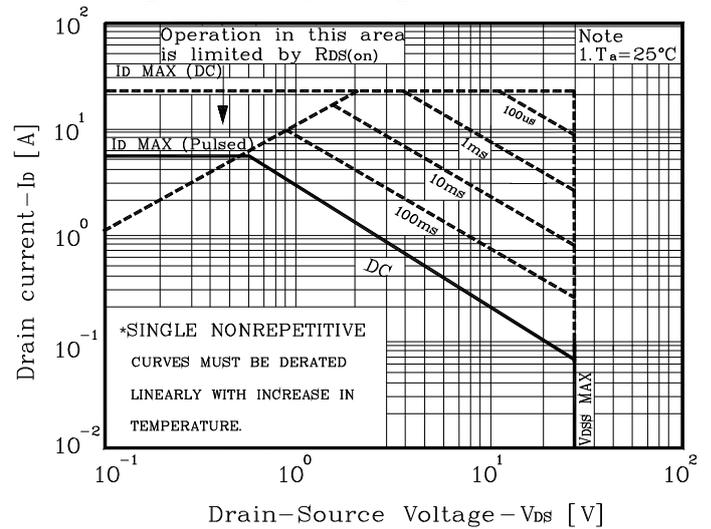


Fig. 11 Gate Charge Test Circuit & Waveform

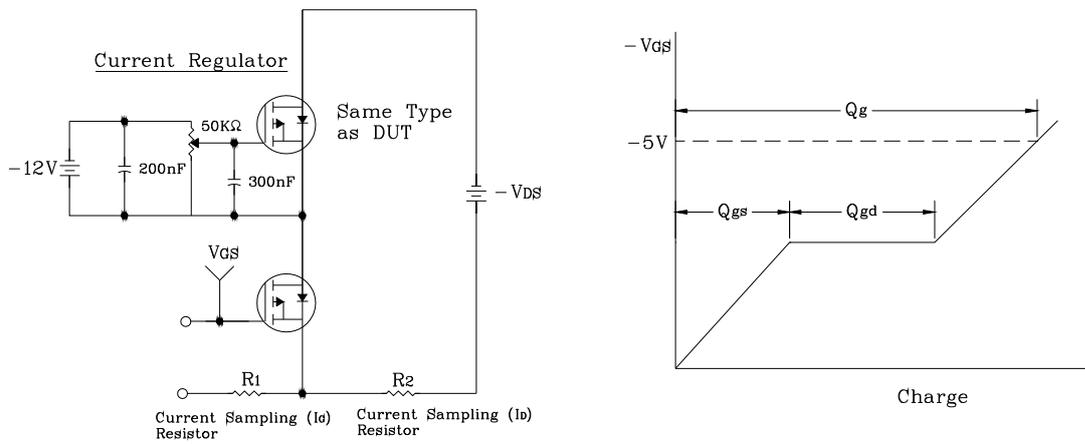


Fig. 12 Resistive Switching Test Circuit & Waveform

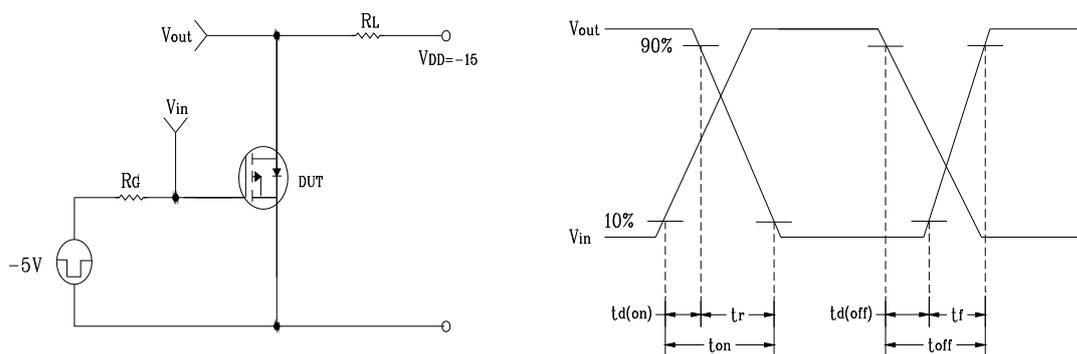


Fig. 13 E<sub>AS</sub> Test Circuit & Waveform

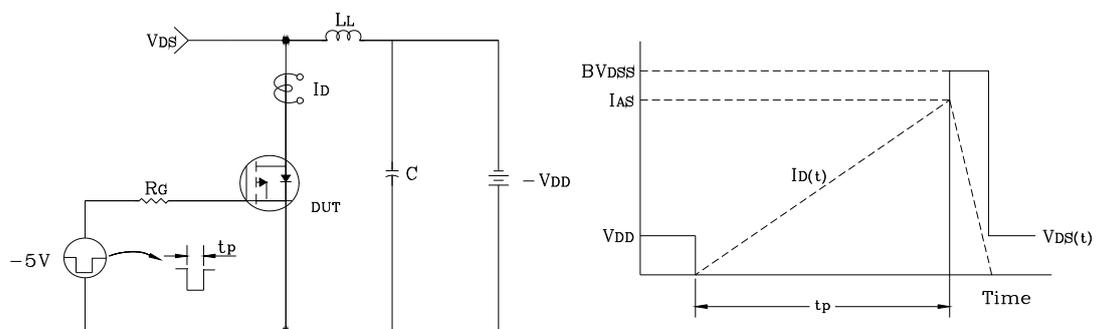
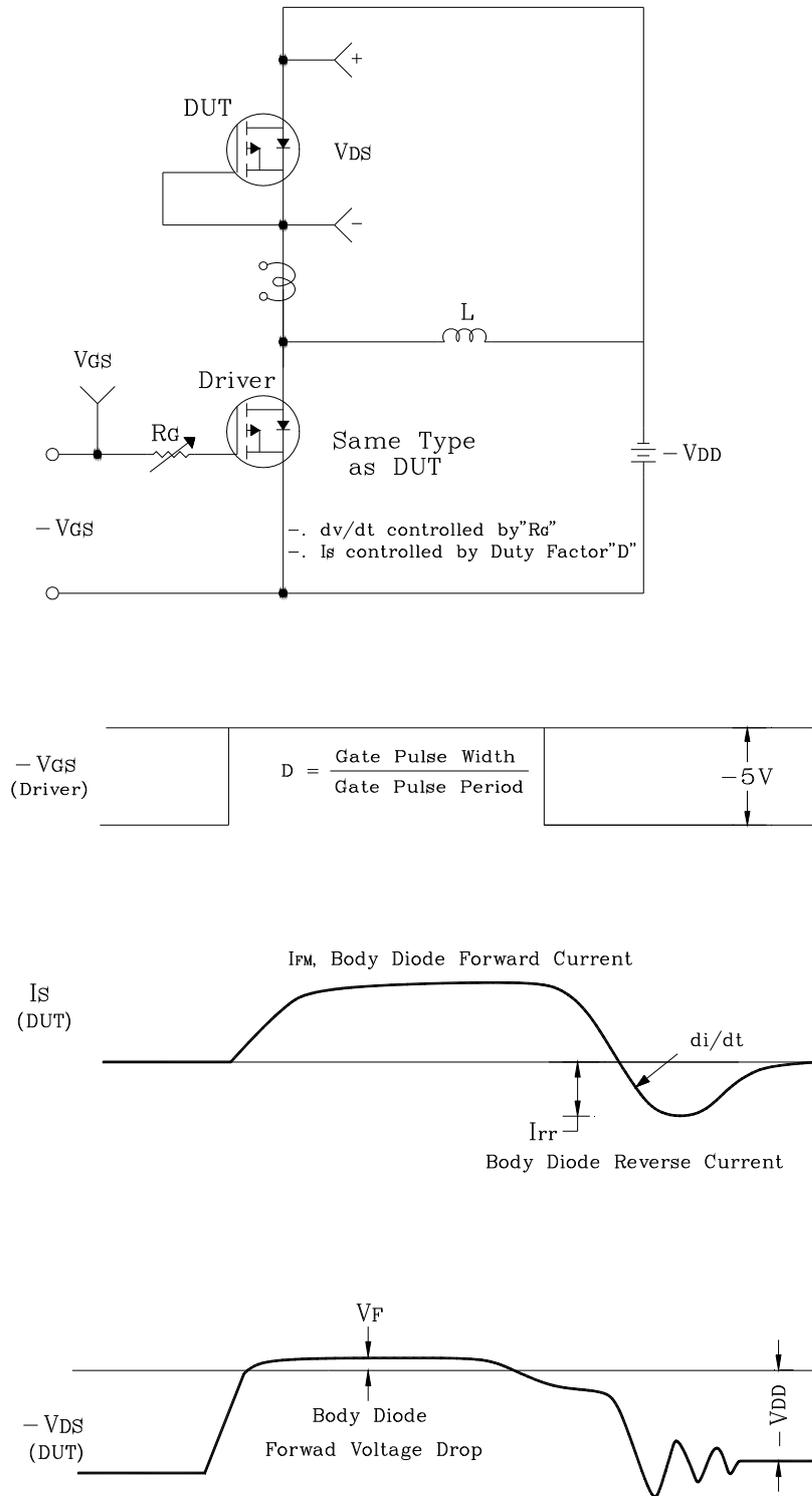
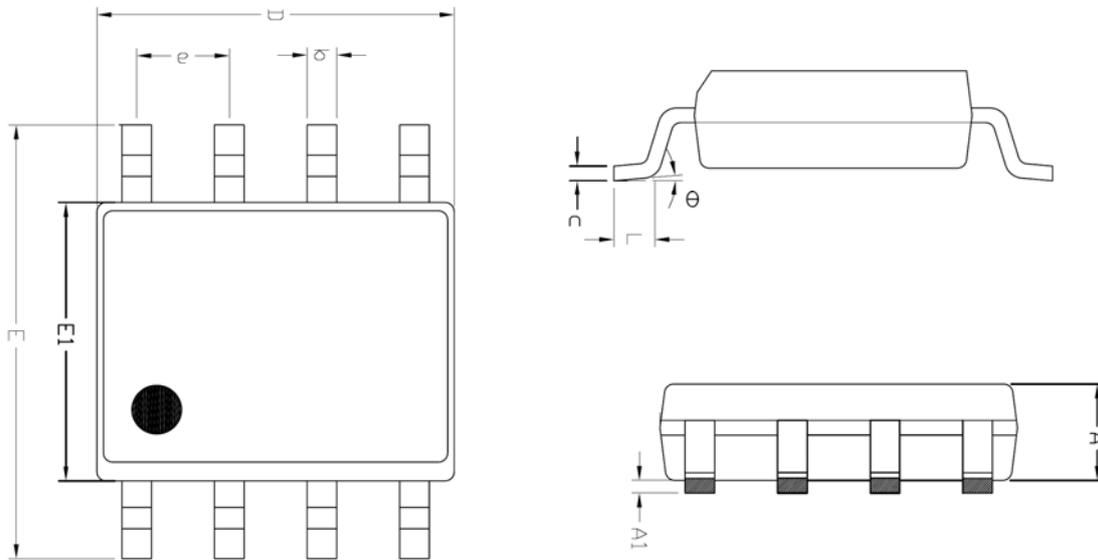


Fig. 14 Diode Reverse Recovery Time Test Circuit & Waveform

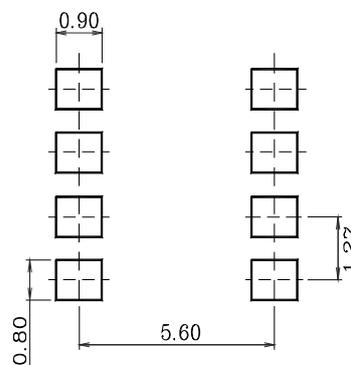


Package Outline Dimensions



| SYMBOL | MILLIMETER(mm) |         |         | NOTE |
|--------|----------------|---------|---------|------|
|        | MINIMUM        | NOMINAL | MAXIMUM |      |
| A      | 1.245          | —       | 1.445   |      |
| A1     | 0.125          | 0.175   | 0.275   |      |
| b      | 0.320          | 0.420   | 0.520   |      |
| c      | 0.170          | 0.220   | 0.270   |      |
| D      | 4.802          | 4.902   | 5.002   |      |
| E      | 5.870          | 6.020   | 6.170   |      |
| E1     | 3.761          | 3.861   | 3.961   |      |
| e      | 1.270 BSC      |         |         |      |
| L      | 0.462          | 0.562   | 0.662   |      |
| theta  | 0 °            | —       | 8 °     |      |

※ Recommended Land Pattern [unit: mm]



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